11th ICIVC
IMAGE, VISION AND COMPUTING

The 11th International Conference on Image, Vision and Computing

Co-sponsors : kunming university of Science and Technology, IEEE

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http://icivc.org/ | **July 17–19, 2026** | **Kunming, China**

Important Dates

- Submission Deadline: March 1, 2026
- Notification of Acceptance: April 1, 2026
- Registration Deadline: April 15, 2026

TRACK 3

Computer Vision Techniques and Application

Track Chair

Assoc. Prof. Yi Zhang

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Call for Papers

Topics of interest include, but are not limited to:

- Data visualization
- Gaze tracking
- Graphical user interfaces
- Handwriting recognition
- Rendering Techniques
- Modeling and Animation
- Image and Video Retrieval
- Video analysis and processing

Full topic list: http://icivc.org/cfp.html

Submission

Submit via EasyChair:

http://www.easychair.org/conferences/?conf=icivc2026

(Choose Track 3)

Or email to: icivc_conf@163.com

Notes:

Papers must be written in English, at least 4 pages in length, and follow the conference template.

Abstract-only submissions are accepted for oral presentation (no publication).

Detailed instructions: http://icivc.org/sub.html

Conference Venue

yunnan Fontaine Blanche Hotel

Address: No. 768, Juxian Street, kunming university Town, Chenggong District, kunming City

Contact

Conference Secretary: Ms. Lorraine

weChat: iconf-cs-2

(please note "ICIVC 2026" when adding)

Publication

All accepted and presented papers will be included in the ICIVC 2026 Conference Proceedings, published by IEEE, and submitted for indexing in Ei Compendex and Scopus.

ICIVC has a consistent publication and indexing record:

ICIVC 2025 | IEEE Xplore | ISBN: 979-8-3503-9261-6
ICIVC 2024 | IEEE Xplore | ISBN: 979-8-3503-8598-4
ICIVC 2023 | IEEE Xplore | ISBN: 978-8-3503-3522-4
ICIVC 2022 | IEEE Xplore | ISBN: 978-1-6654-6733-9
ICIVC 2021 | IEEE Xplore | ISBN: 978-1-6654-4367-8
ICIVC 2020 | IEEE Xplore | ISBN: 978-1-5386-2892-8

For more details, please visit: https://icivc.org/pub.html

Conference Program

July 17: Registration & Material Collection
July 18: Opening Ceremony, Keynote Speeches, Group Photo, Parallel Sessions
July 19: Oral & Poster Sessions

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